

## REPORT DOCUMENTATION PAGE

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## **Report Title**

New Approaches for Characterization of Heterogeneous Material Integration Quality

## **ABSTRACT**

2013 North American Molecular Beam Epitaxy Conference -Post-Conference Workshops,, Banff, Alberta, Canada  
(October 5-11 2013)

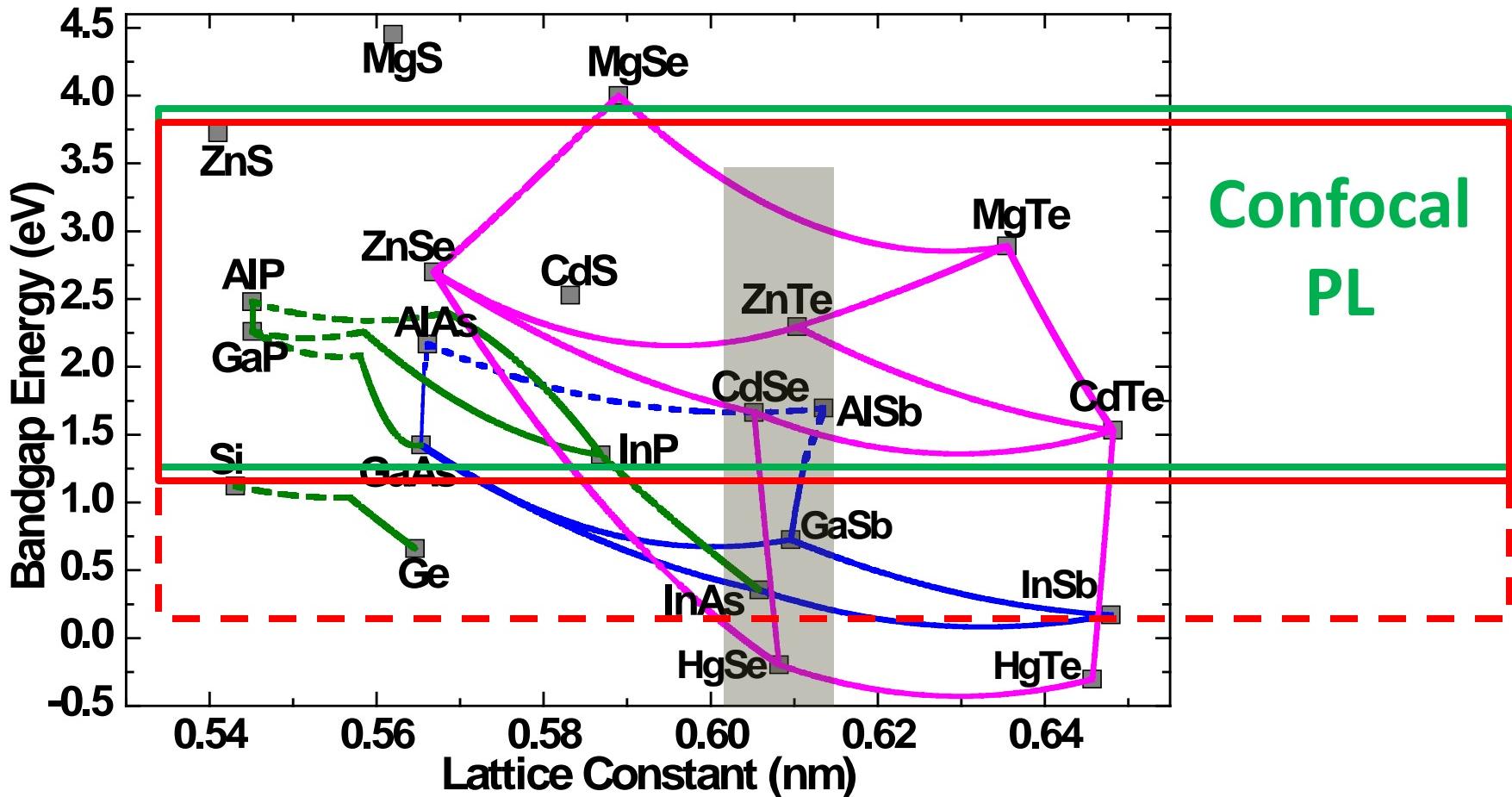
# New Approaches for Characterization of Heterogeneous Material Integration Quality

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Materials Science, Engineering, and Commercialization Program  
Texas State University – San Marcos

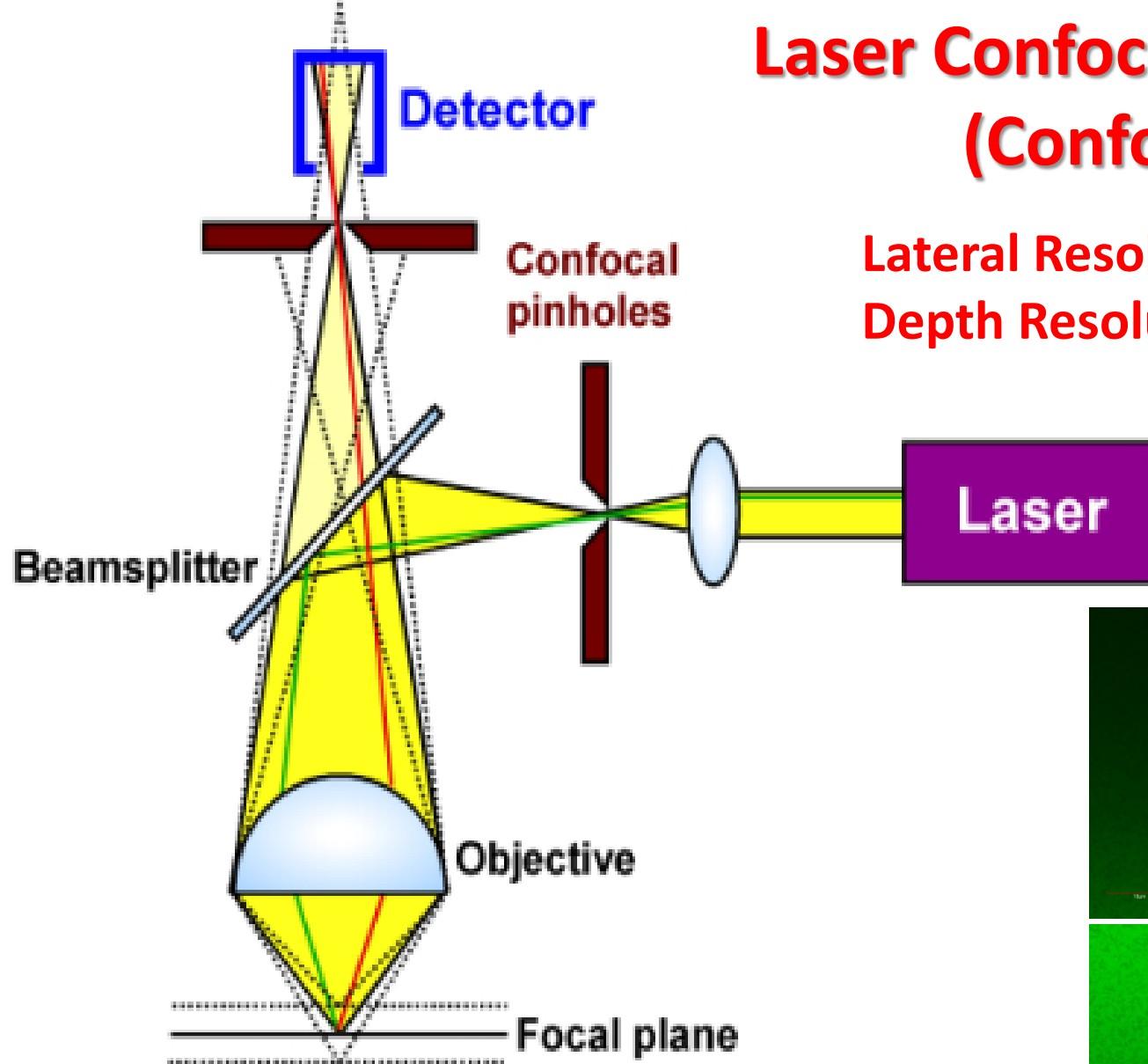
This work is supported by, or in part by, the U. S. Army Research Laboratory and the U. S. Army Research Office under contract/grant number W911NF-10-2-0103, W911NF-10-1-0335, and W911NF-10-1-0524.

# Cathodoluminescence



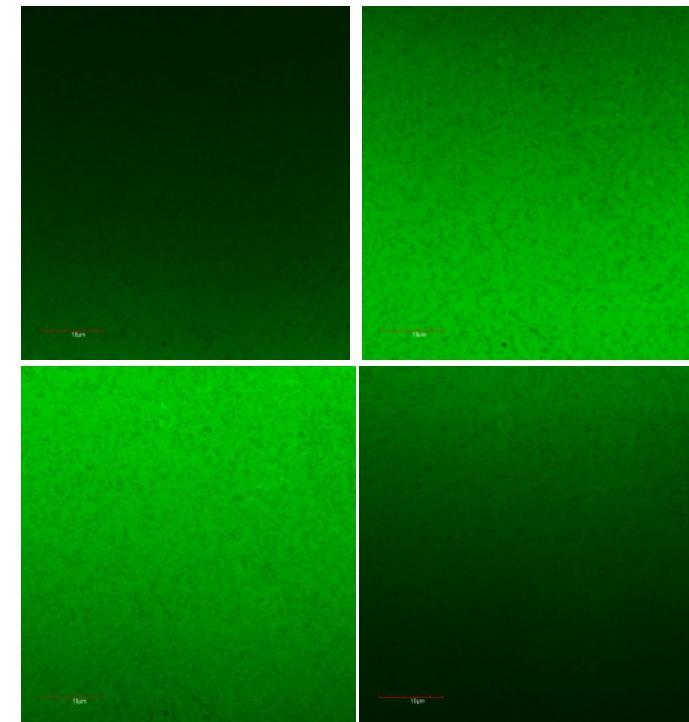
The **6.1 Å Alloy System** can be used to grow a host of nearly lattice matched materials (III-V and II-VI), from infrared to UV

# Laser Confocal Microscopy (Confocal PL)



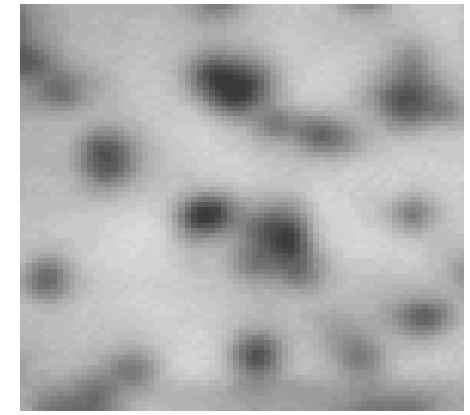
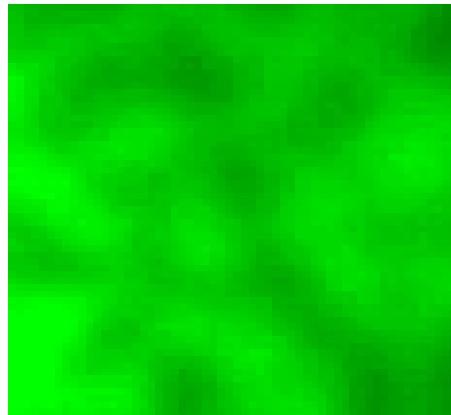
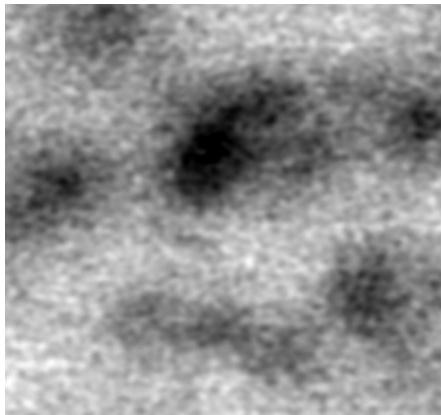
Lateral Resolution  $0.25 \mu\text{m}$   
Depth Resolution  $0.25\text{-}0.5 \mu\text{m}$

$0.25 \mu\text{m}$  Steps on  
 $0.25 \mu\text{m}$  Thick ZnTe



# Confocal PL provides highest contrast

Cathodoluminescence      Imaging      Confocal  
Photoluminescence      Photoluminescence      Photoluminescence



5  $\mu\text{m}$

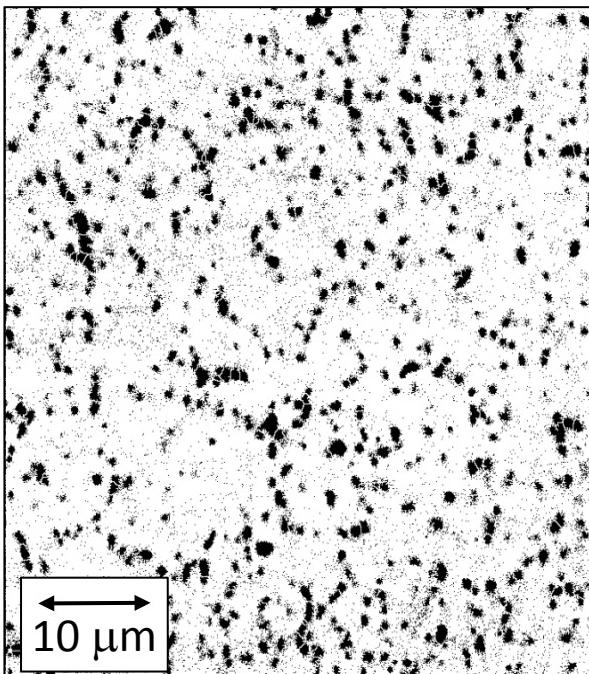
1000 nm ZnTe

## Olympus FV1000 Laser Scanning Confocal Microscope

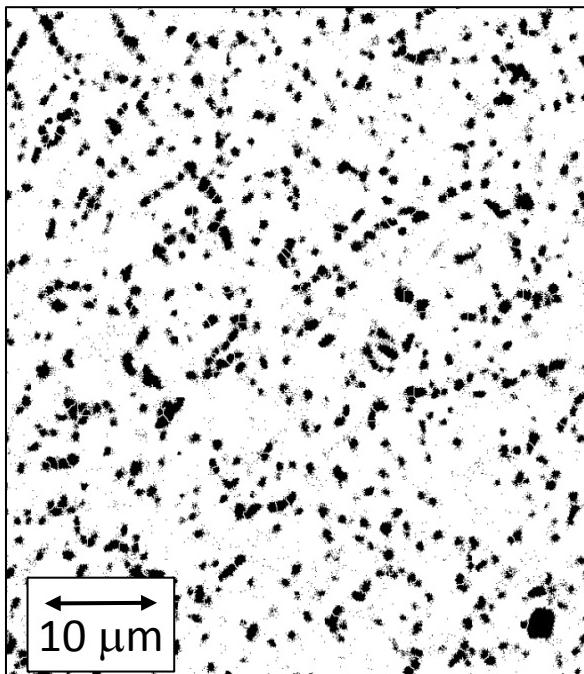


- high-resolution confocal observation of fixed and living cells,
- point-detection, variable bandwidth filtering, 3-D imaging, and time experiments.
- multi-line Argon lasers: 515, 488, and 458, and Diode lasers 405, 559, and 635.
- brightfield or DIC imaging,
- motorized upright microscope.

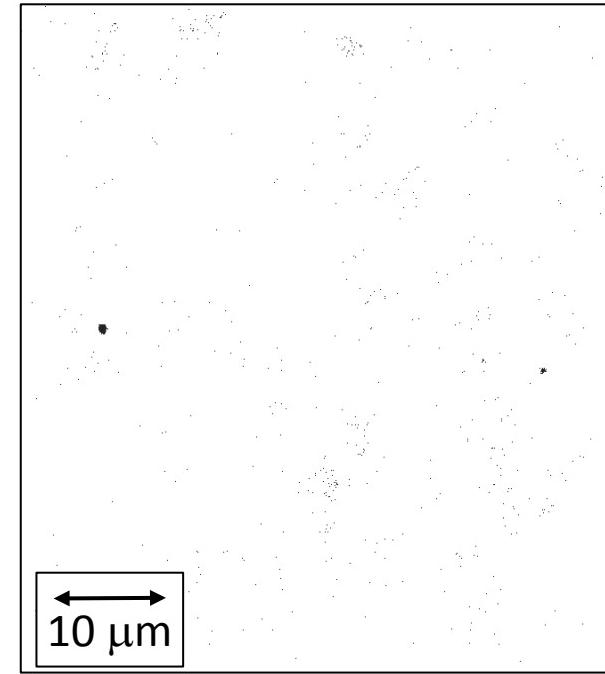
# Effect of Lattice Matching



$\sim 3 \times 10^7 \text{ cm}^{-2}$   
2-μm thick  
ZnTe/GaSb (211)B

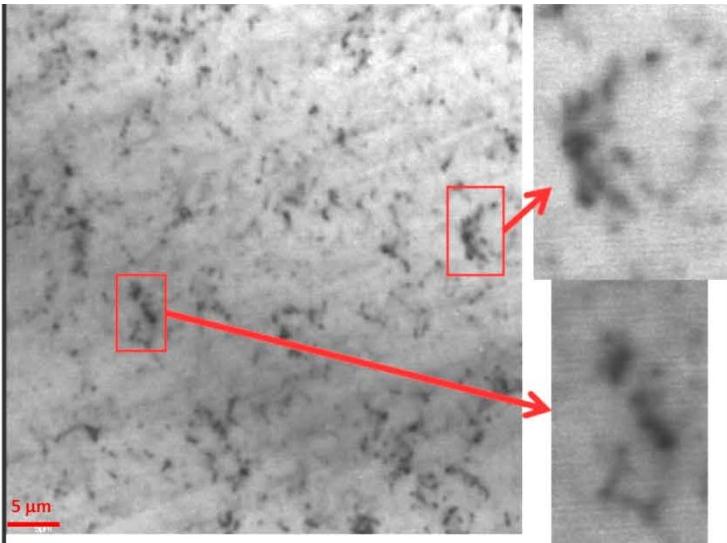


$\sim 3 \times 10^7 \text{ cm}^{-2}$   
2-μm thick  
ZnTe/GaSb (100)

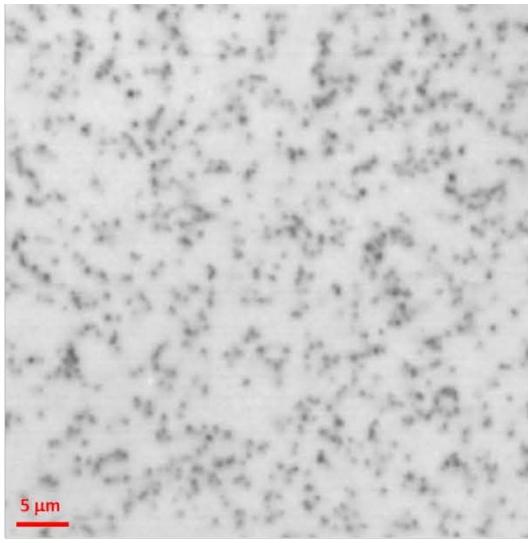


$\sim 7 \times 10^4 \text{ cm}^{-2}$   
1.2-μm thick  
ZnTe<sub>0.99</sub>Se<sub>0.01</sub>/GaSb (211)B

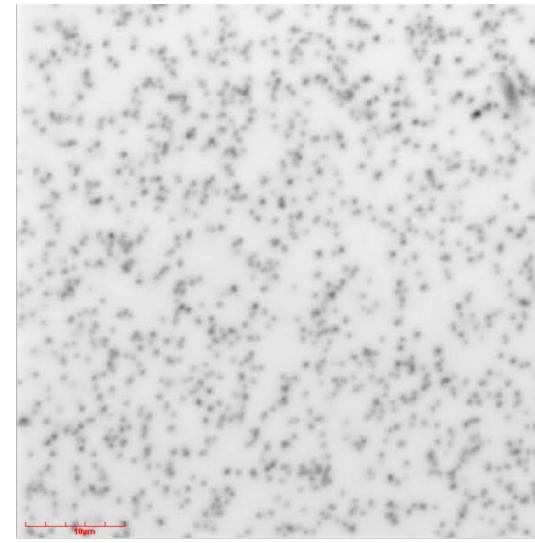
# Evaluation of II-VI Growth on Alternative Substrates



c-PL micrograph of ZnTe/Si suggestive of dislocation clustering with a measured “dislocation” density of  $2 \times 10^7 \text{ cm}^{-2}$

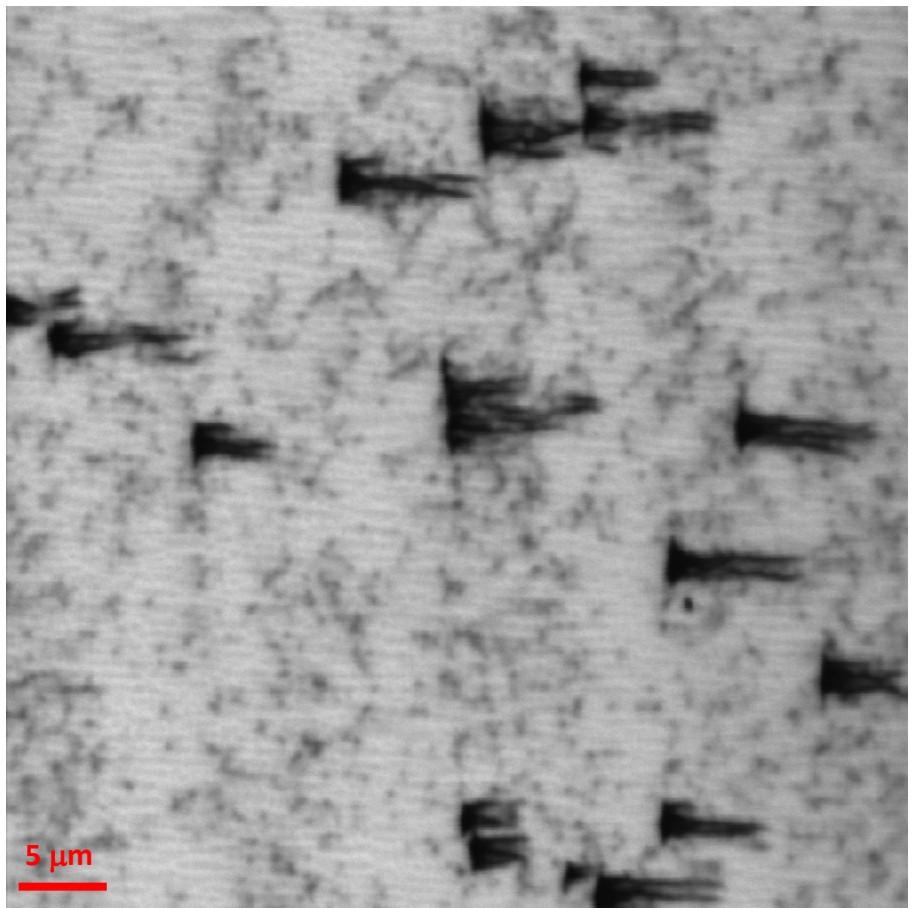


c-PL micrograph of CdTe/Si less suggestive of dislocation clustering with a measured “dislocation” density of  $2 \times 10^7 \text{ cm}^{-2}$



c-PL micrograph of (211)B CdTe/GaAs showing a “non-clustered” defect distribution with a density of  $2 \times 10^7 \text{ cm}^{-2}$ .

# Twin-related Defects



c-PL micrograph of (211)B ZnTe/Si showing twinning occurring during MBE growth



c-PL micrograph of (111)B CdTe/CdTe showing twinning occurring during MBE growth

# Cathodoluminescence

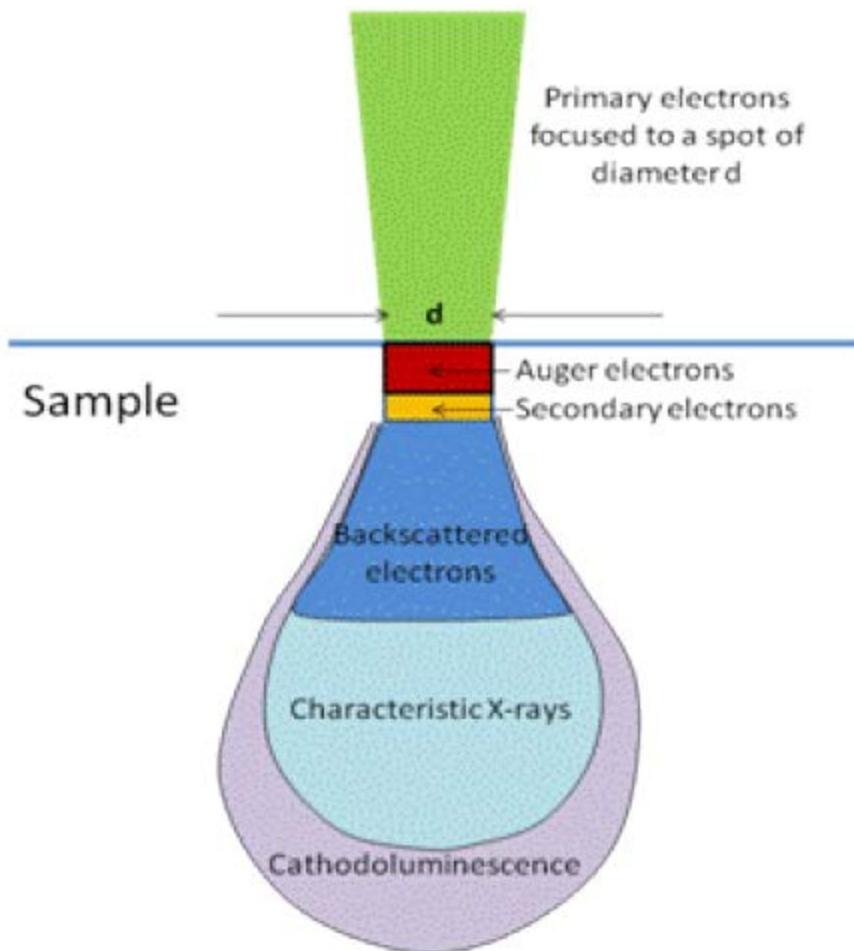
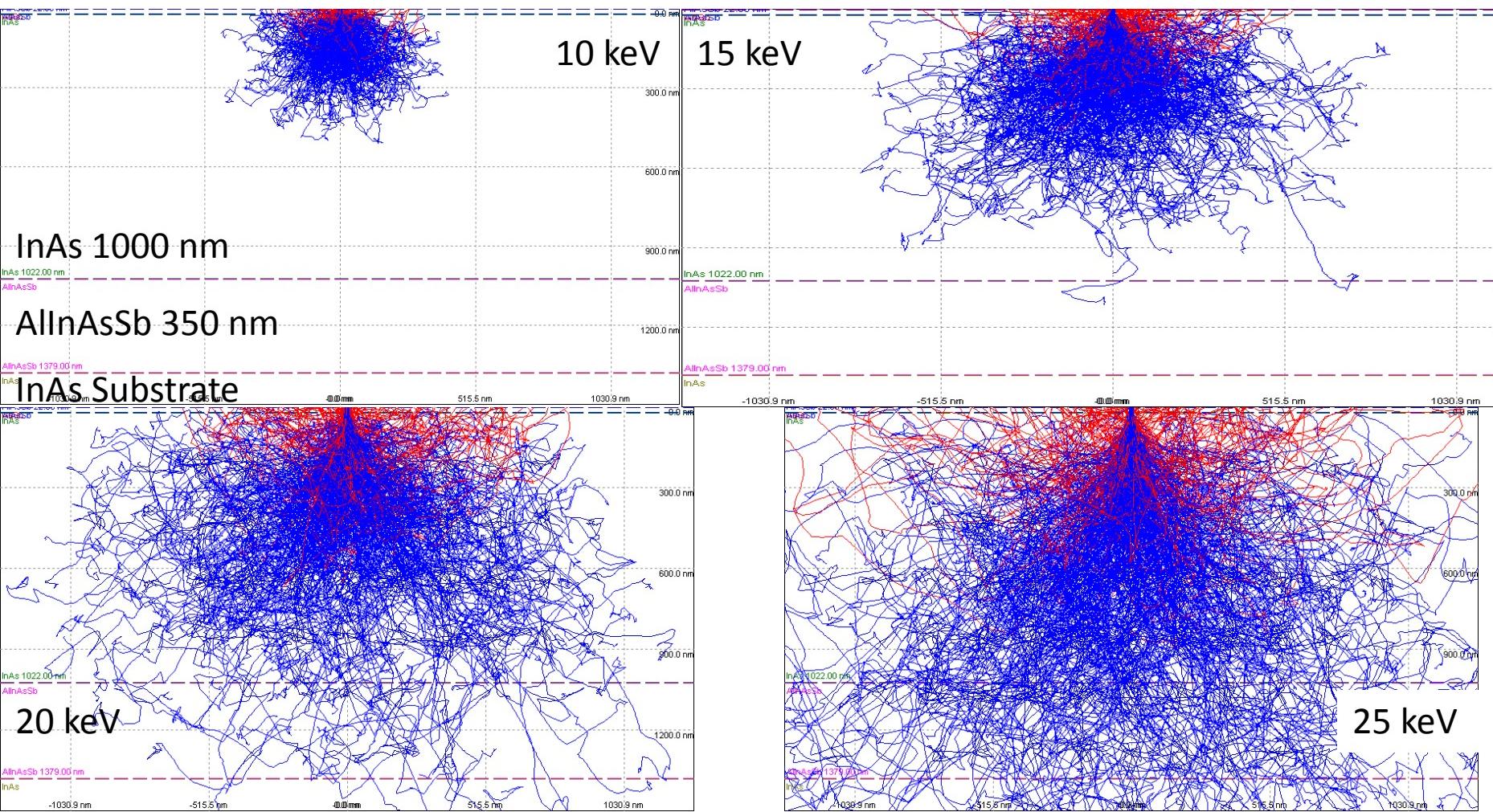
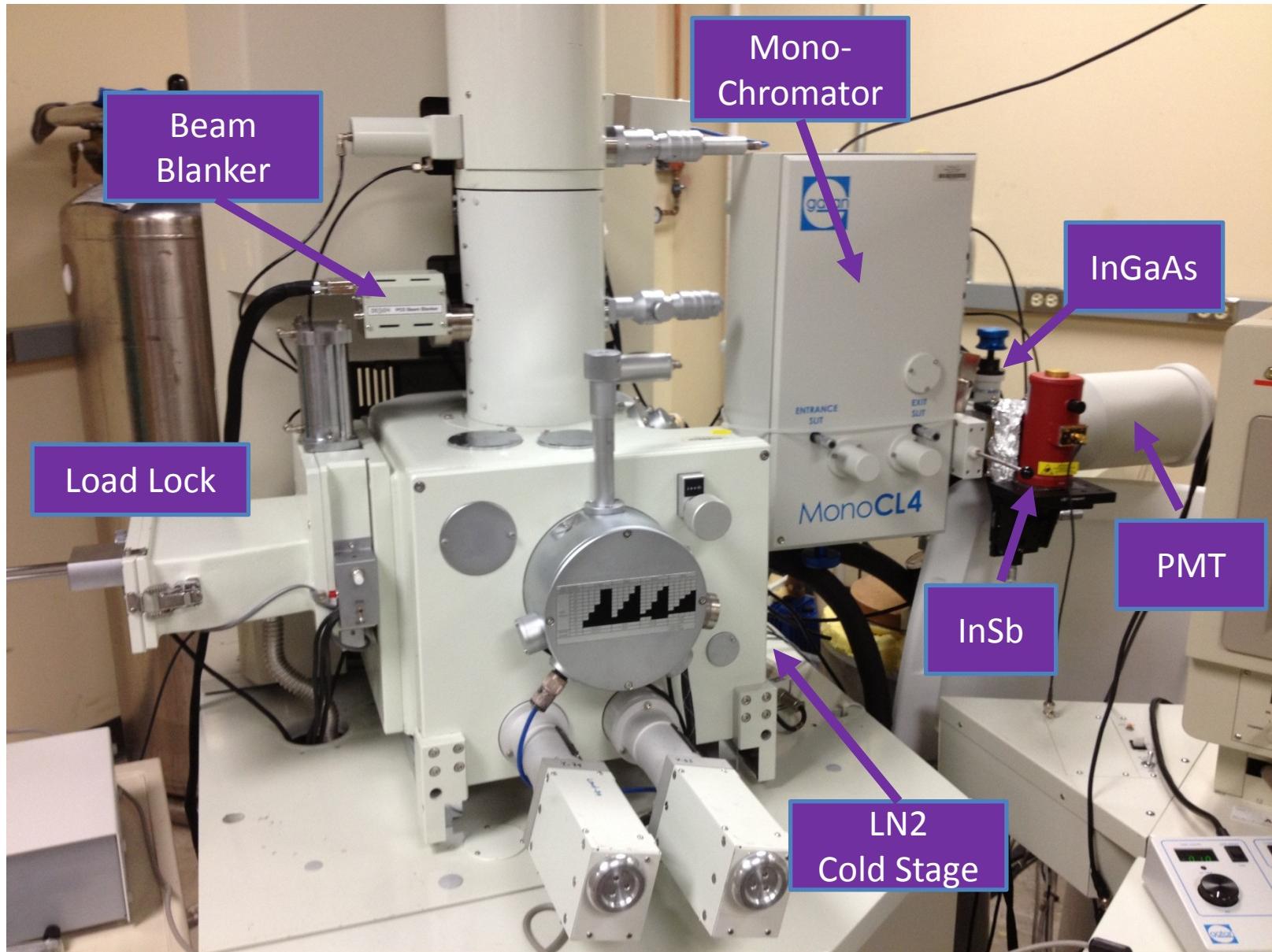
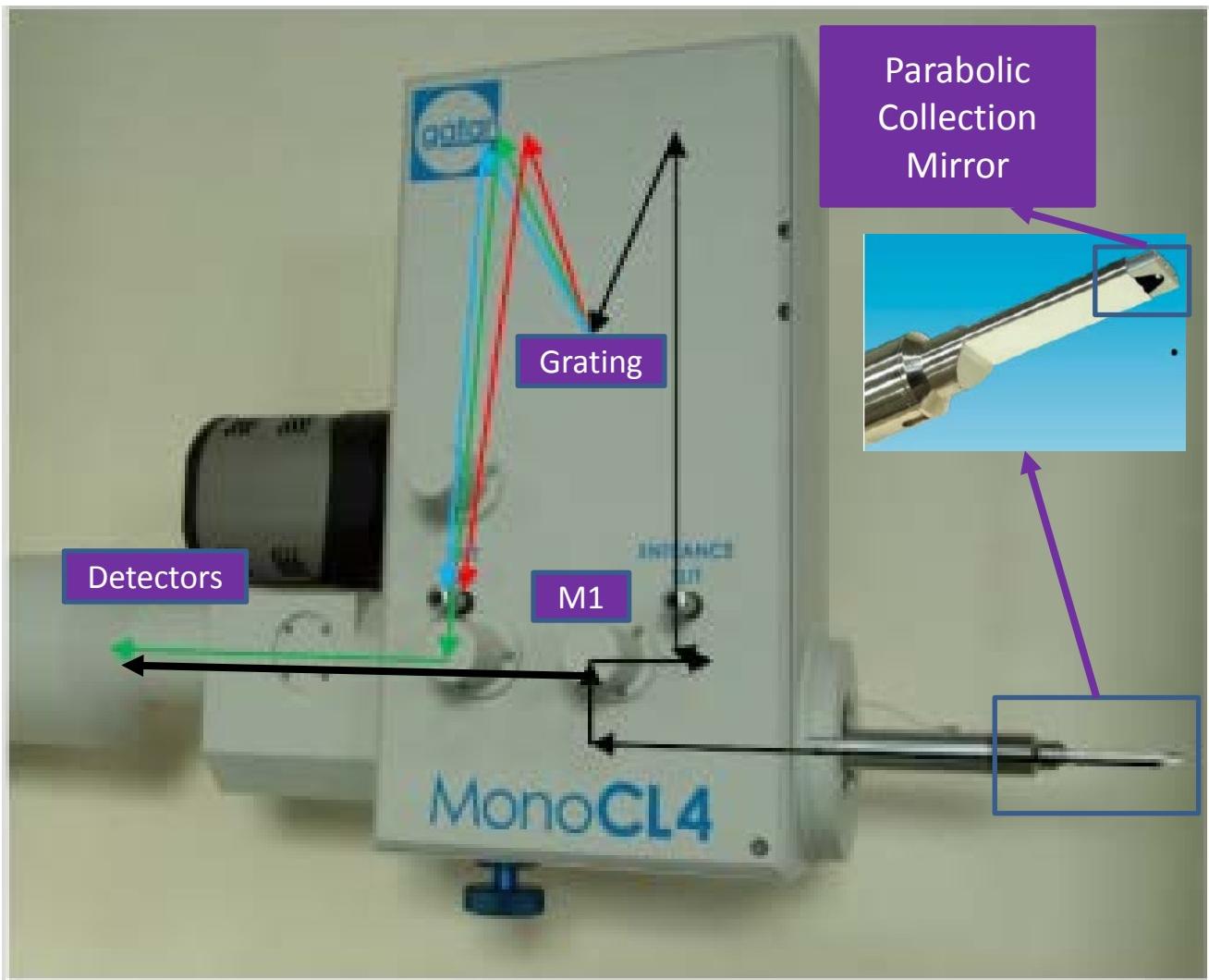


Figure 23 - the generation (interaction) volume and the location of some of the signals generated within it



# Simulation of Electron Penetration





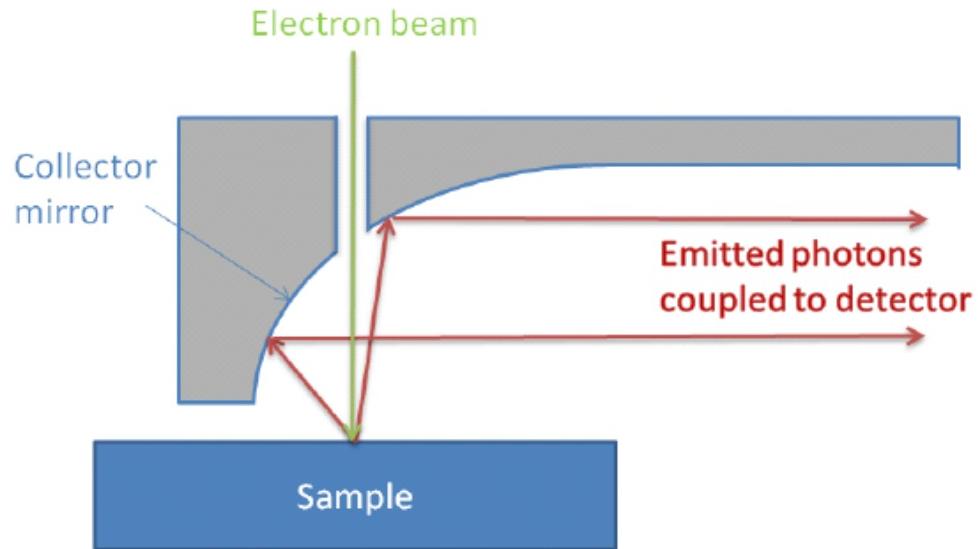
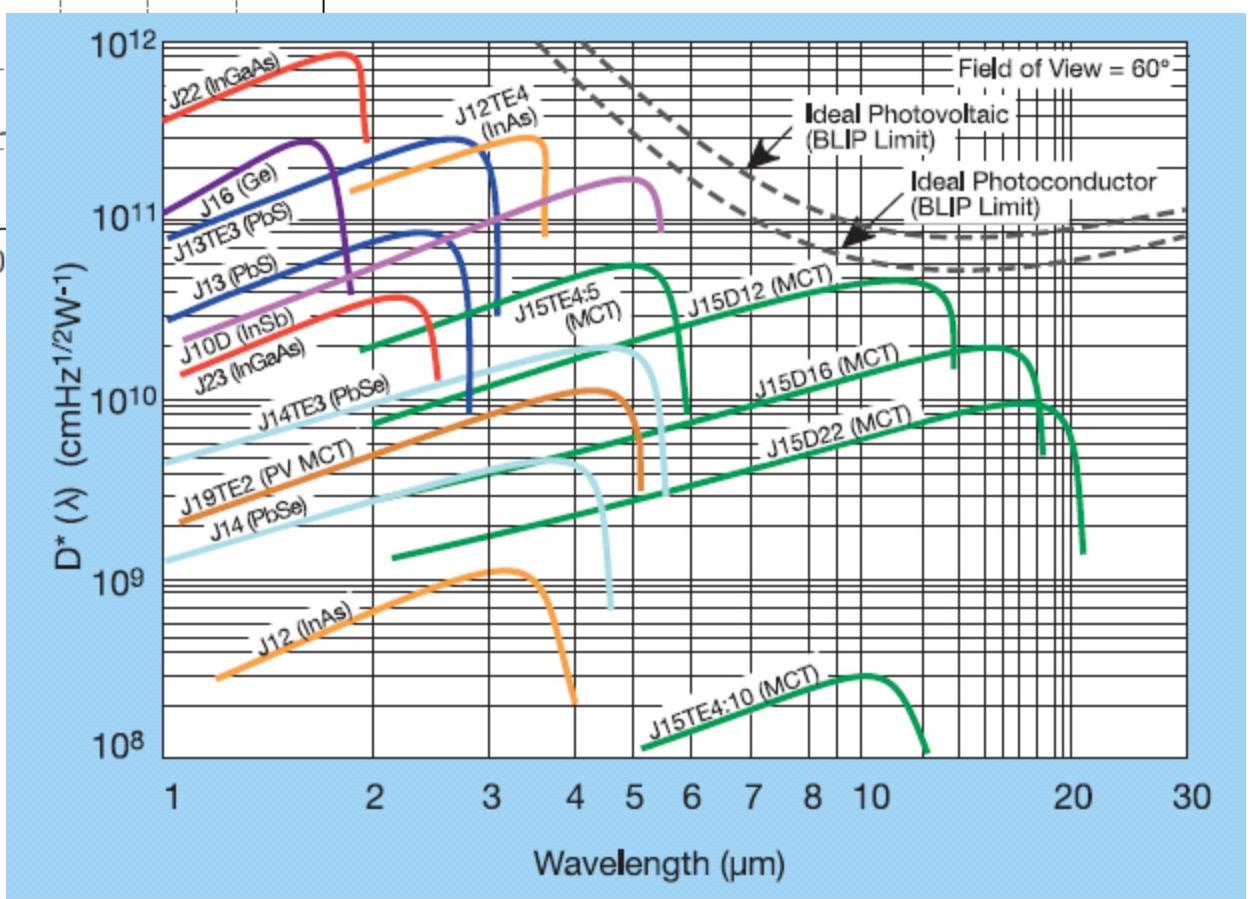
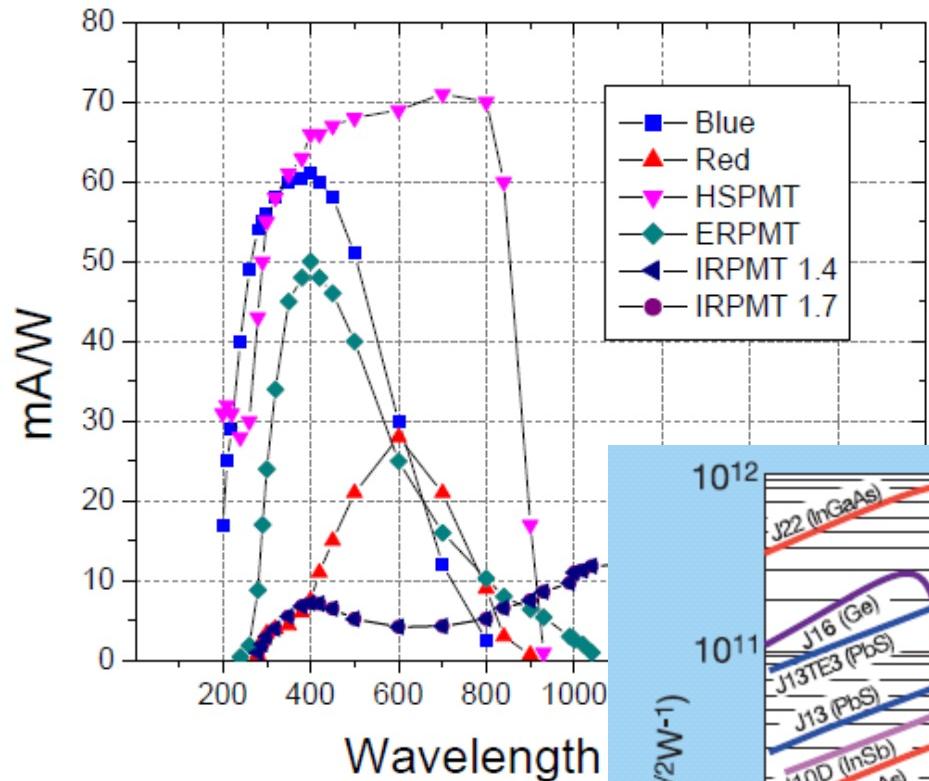


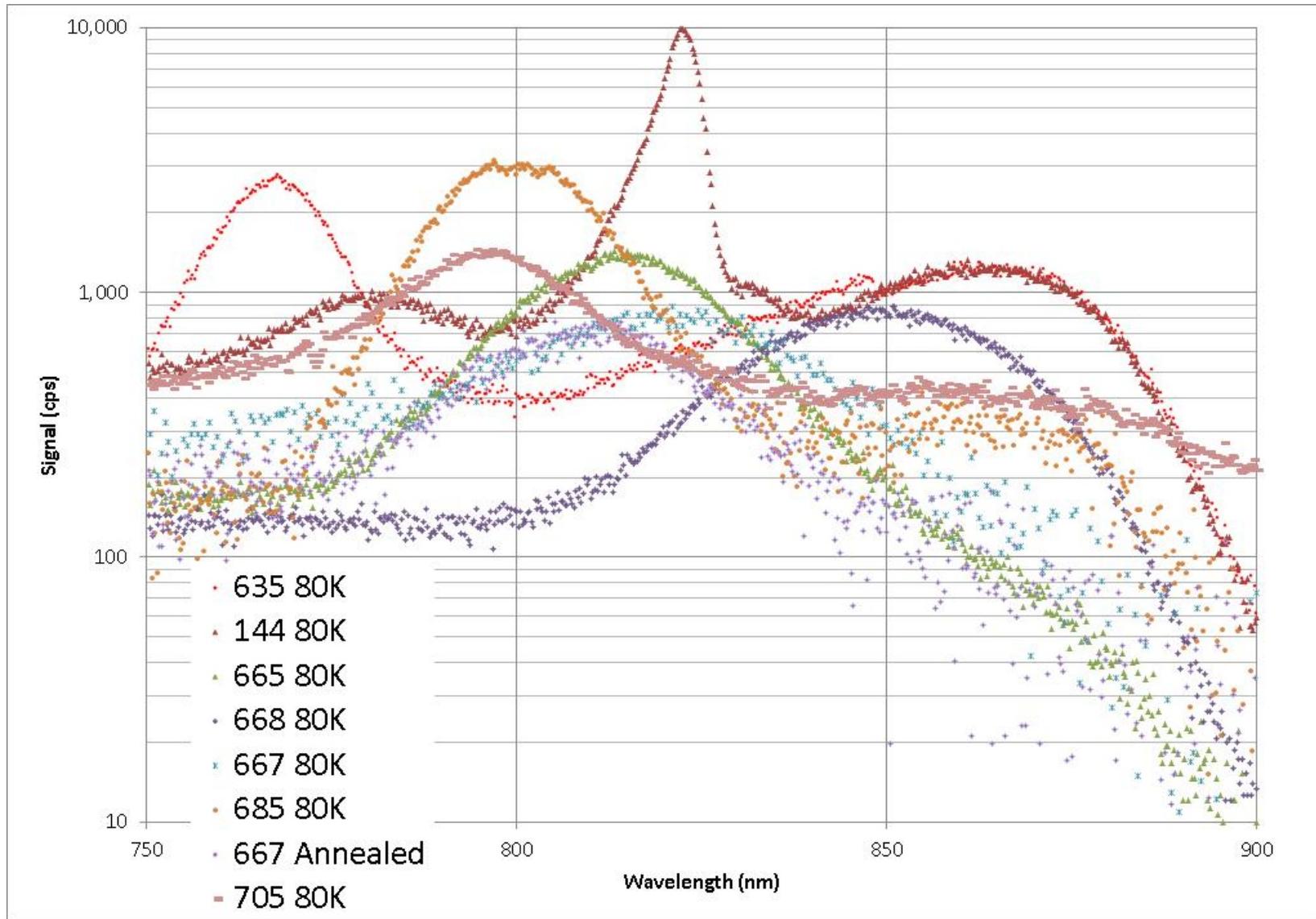
Figure 24 - schematic representation of CL setup with a parabolic mirror used to couple photons efficiently to a detector

**Very High Collection Efficiency  
> 75%**

# Detector Sensitivity

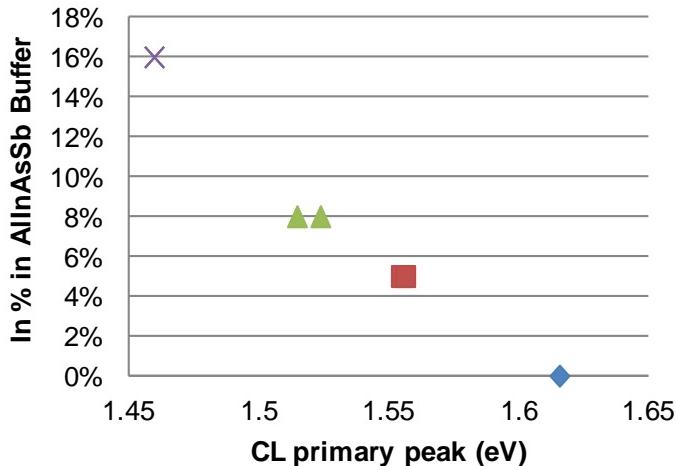


# Indirect gap layer - InAlAsSb

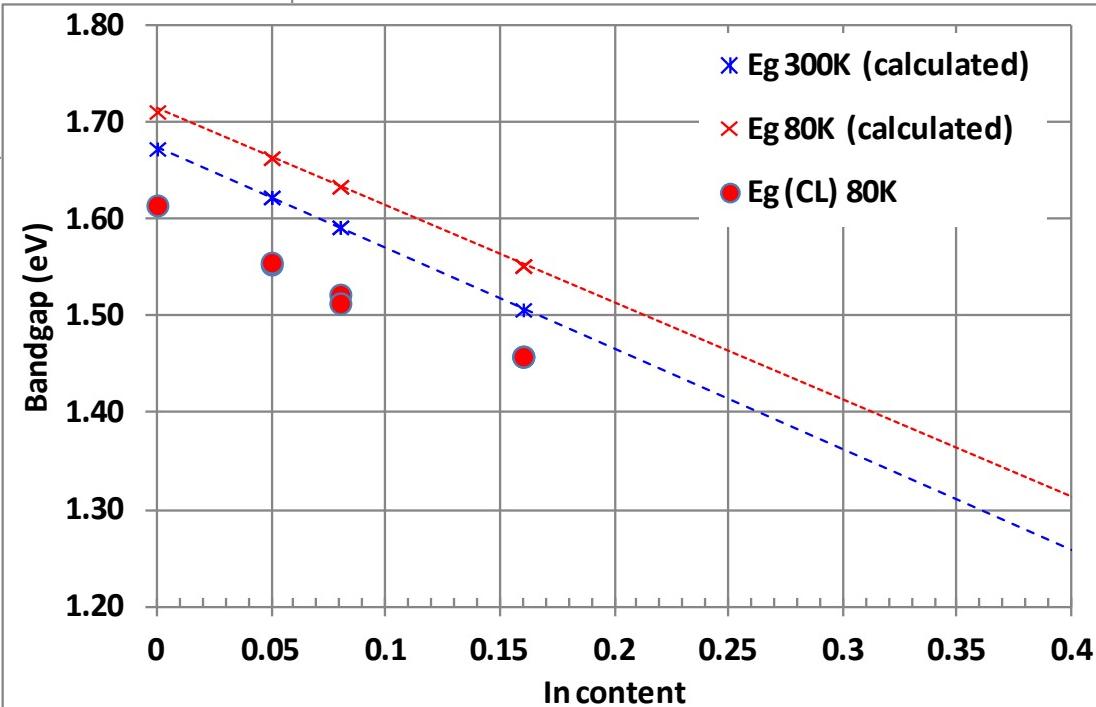


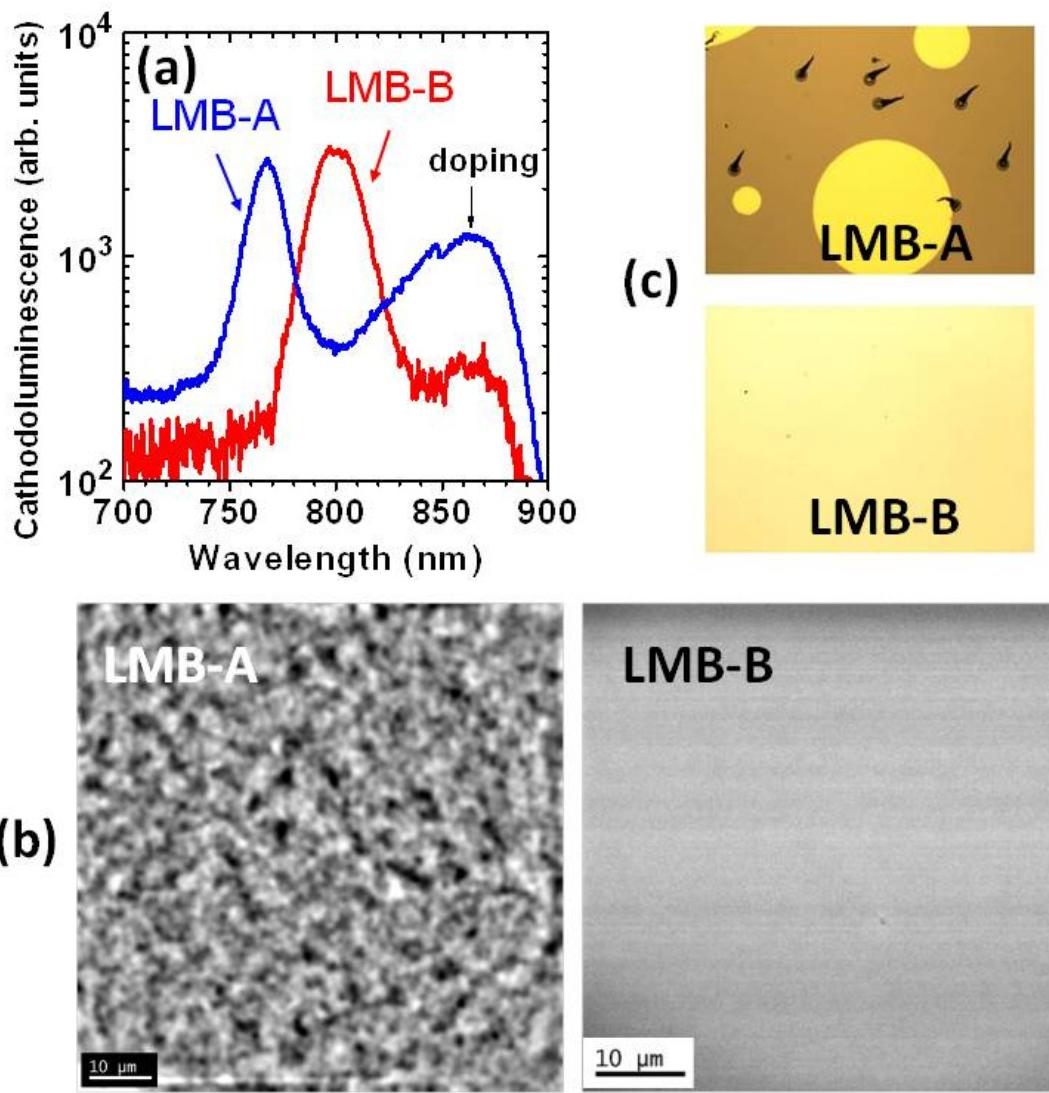
# Estimated In% and Calculated Eg in AlInAsSb vs Eg from CL Primary Peak

Variation of In % vs CL peak  
in Al(In)AsSb buffer



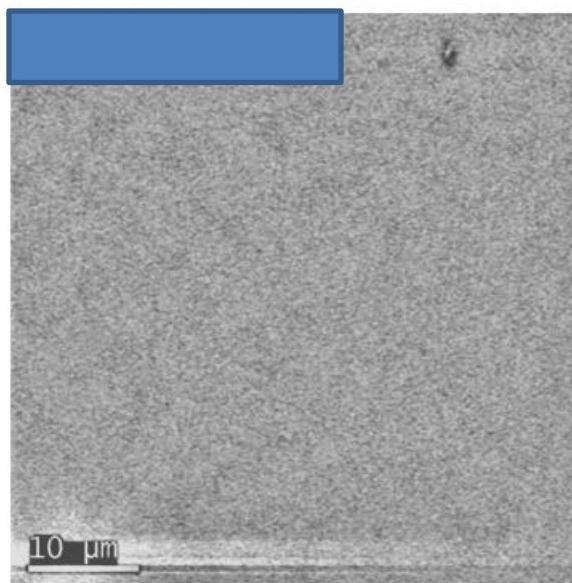
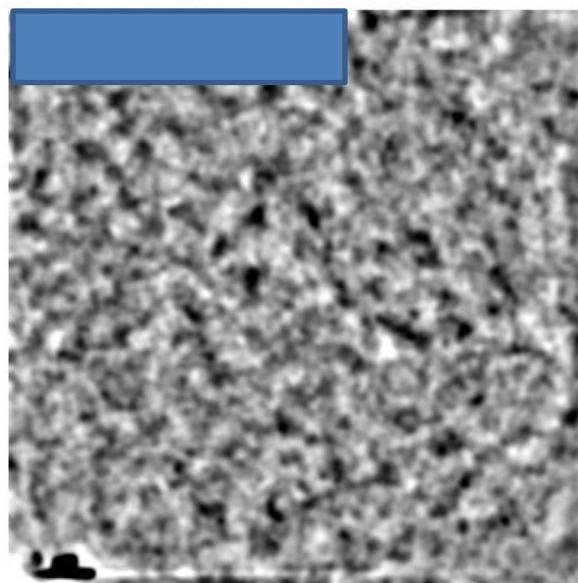
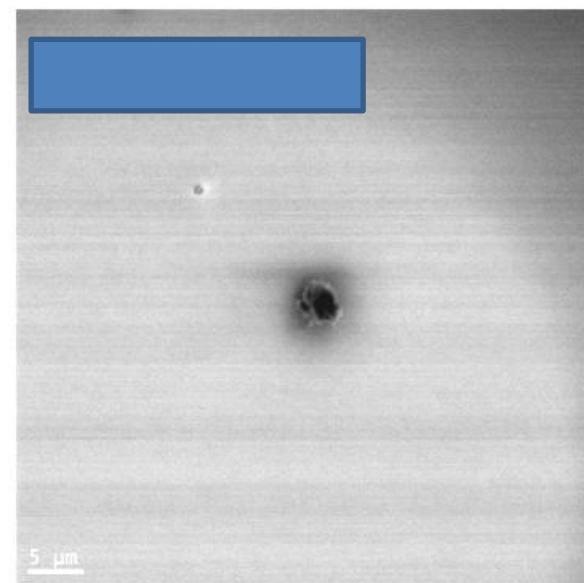
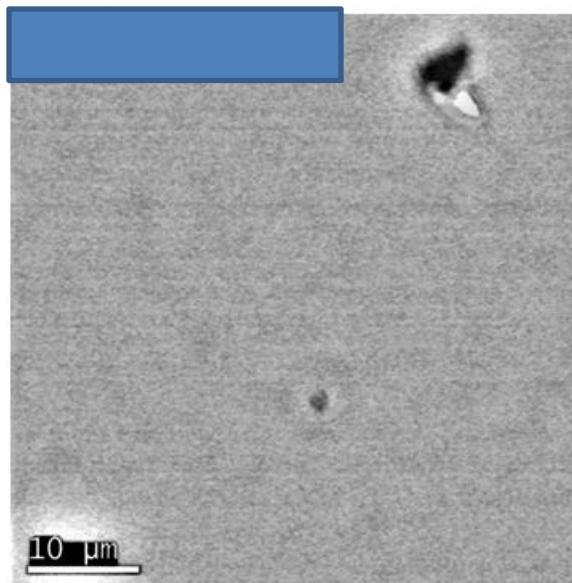
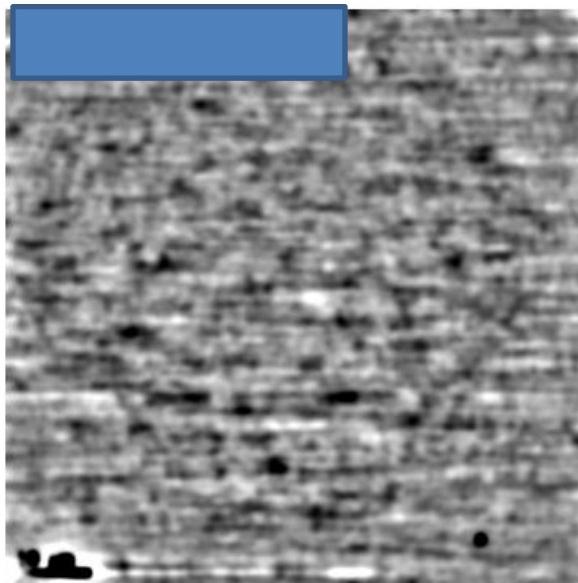
- ◆ AlAsSb, no In
- AllnAsSb, In 5%
- ▲ AllnAsSb, In 8%
- ✗ AllnAsSb, In 16%





(a) CL spectra, (b) panchromatic CL images, and (c) optical images of the InAs surface after exposure to diluted HF of the LMB-A and LMB-B structures of Fig. 4. Defectivity of LMB-A is only revealed in CL images (b) and manifested by attack of defect sites (c).

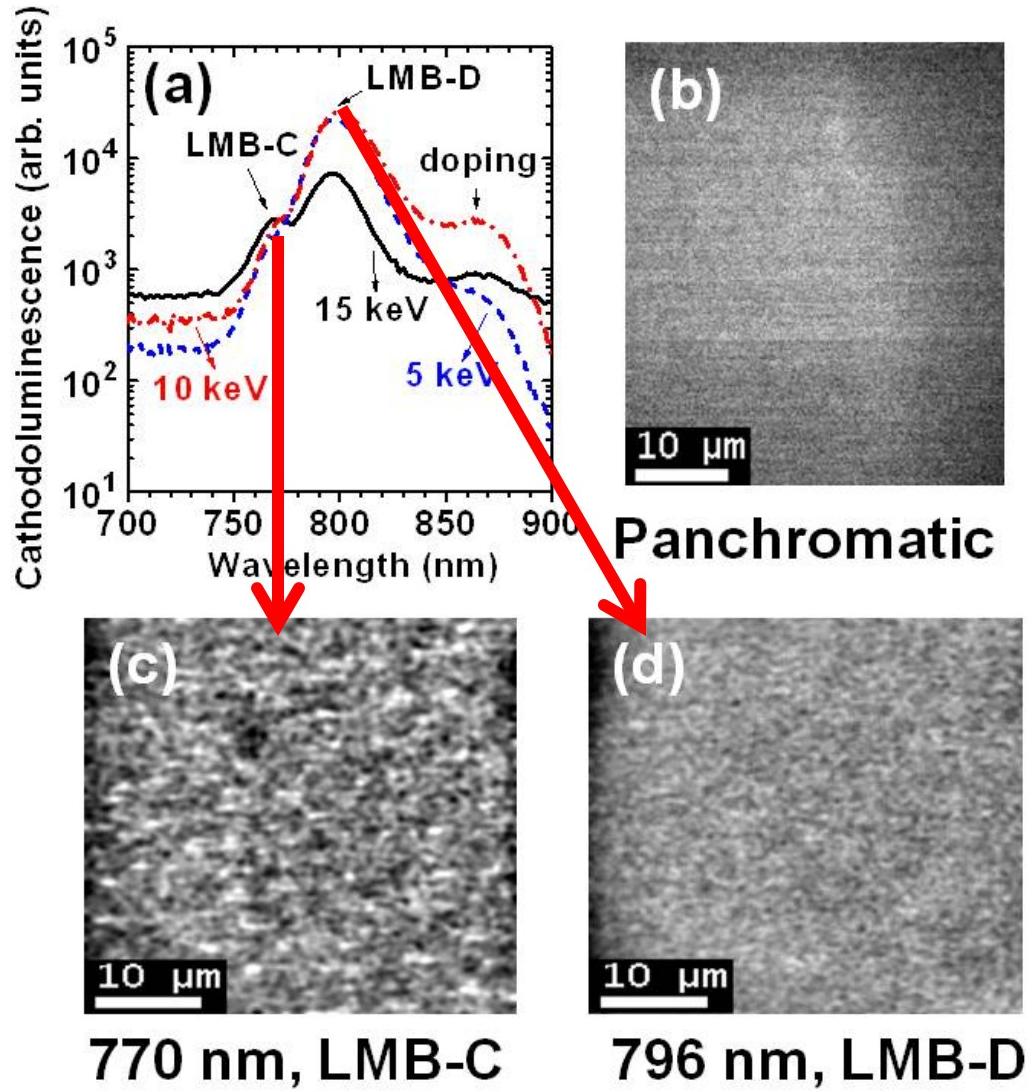
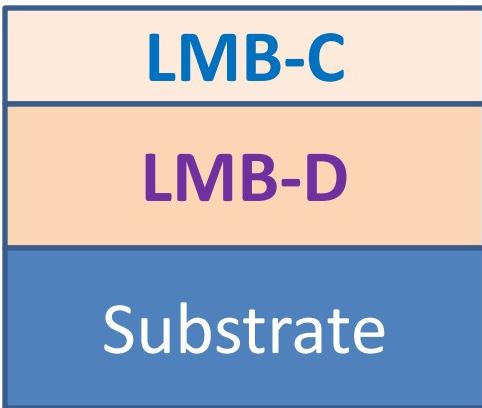
## CL Image Comparison AlInAsSb Different growth conditions (80K)



Defect density  $\sim 10^9 \text{ cm}^{-2}$

Defect density  $\sim 10^5 \text{ cm}^{-2}$

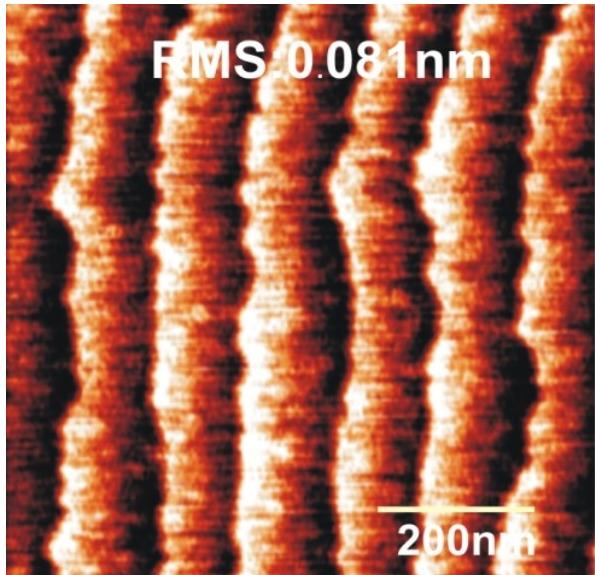
No obvious non radiative defects observed



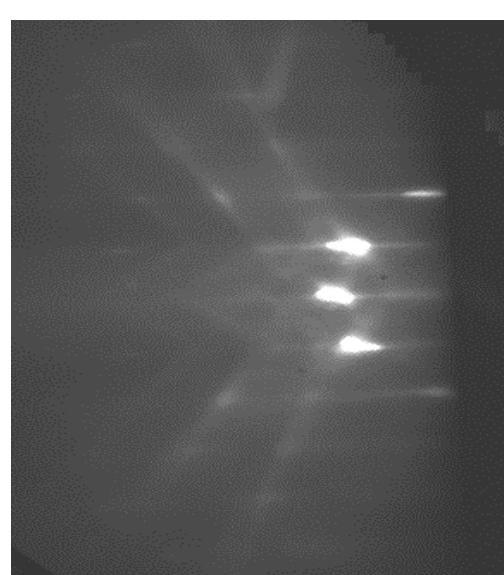
(a) CL spectra, (b) panchromatic CL image, (c) monochromatic CL image of LMB-C and (d) monochromatic CL image of LMB-D. In panchromatic image, the defectivity of LMB-C is not visible whereas monochromatic images show defectivity of LMB-C and defect free LMB-D.

# MBE grown GaSb on GaAs (100)

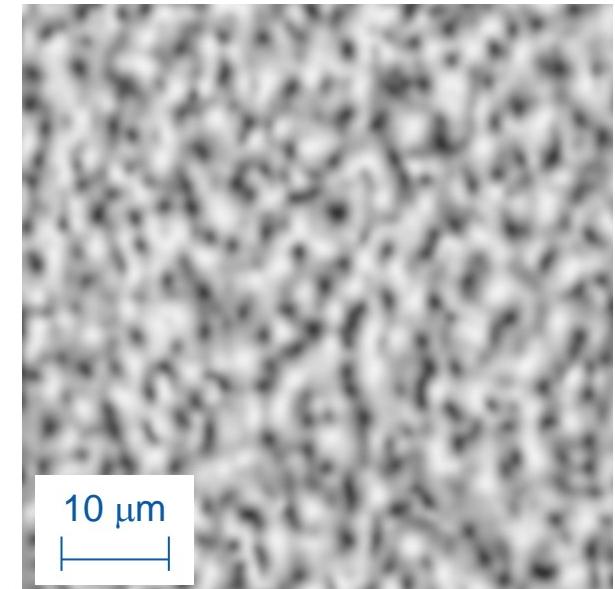
HRXRD FWHM of about 150 arcsecond,



*in-situ* AFM



RHEED

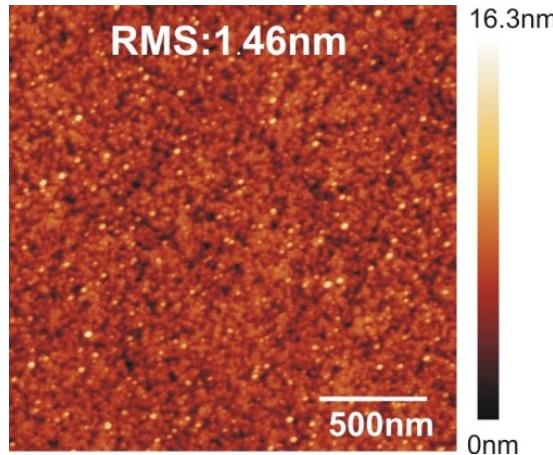


Cathodo-  
luminescence

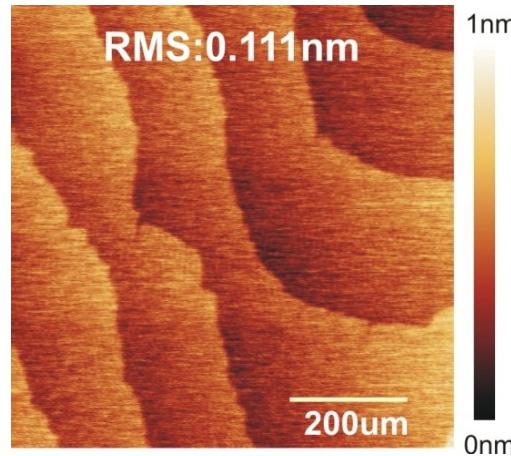
Dislocation density  $\sim 1 \times 10^7 \text{ cm}^{-2}$

# GaSb films on GaSb substrate

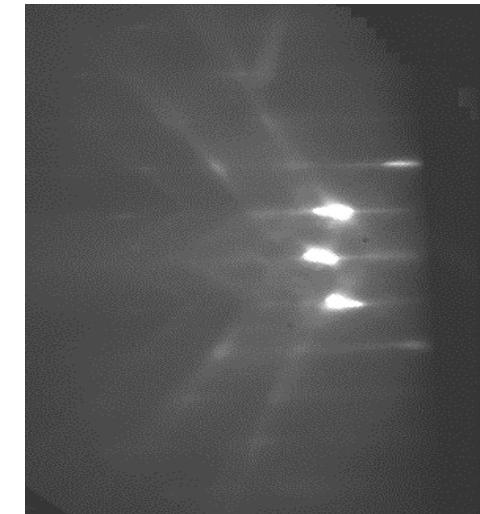
## GaSb (100) homoepitaxial growth



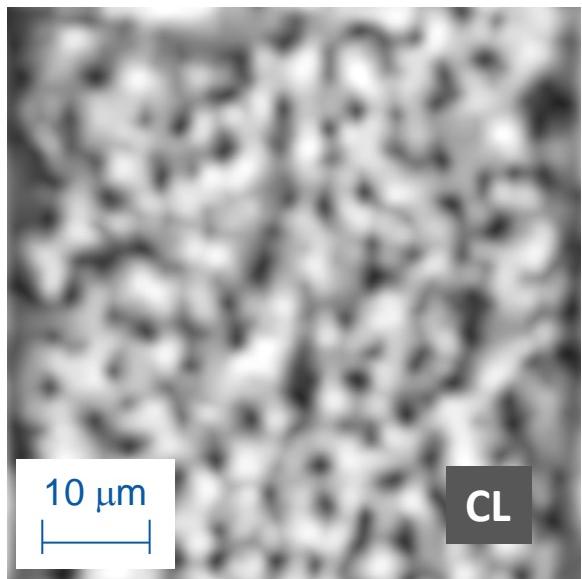
As-Received



GaSb film



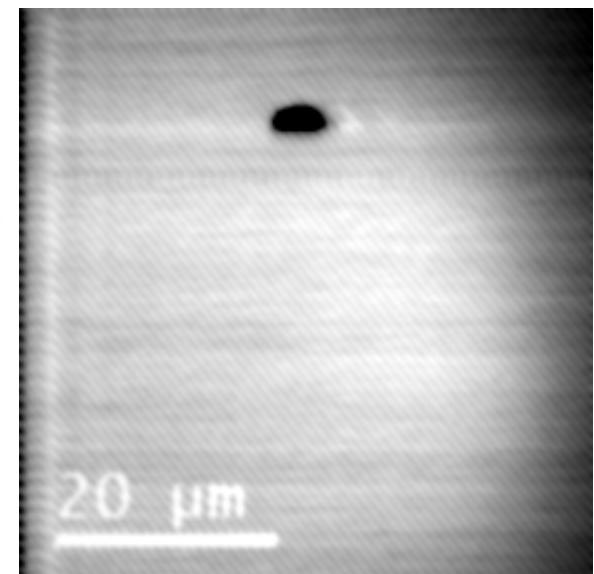
RHEED



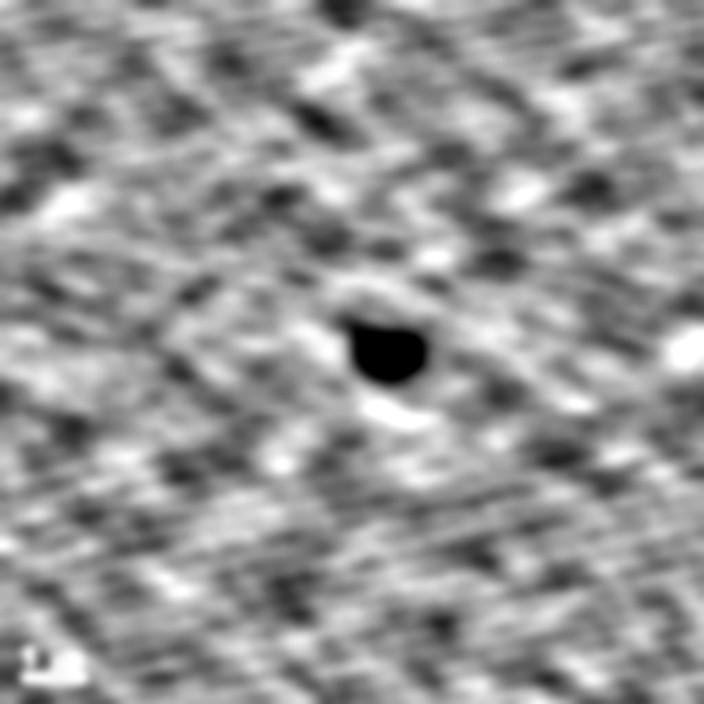
Bad surface prep

GaSb/GaSb  
WaferTech (100) Sub

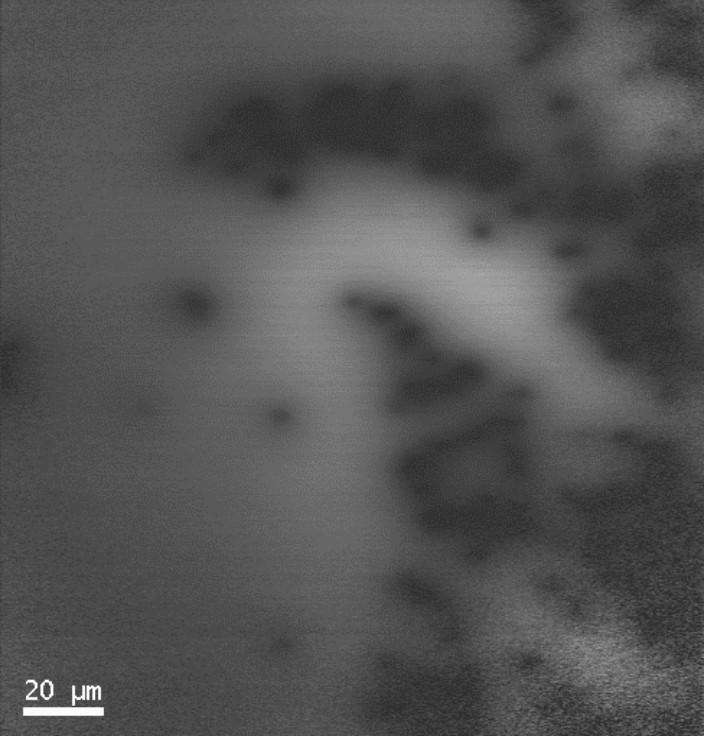
dislocation density  
 $\sim 1 \times 10^5 \text{ cm}^{-2}$



Good surface prep



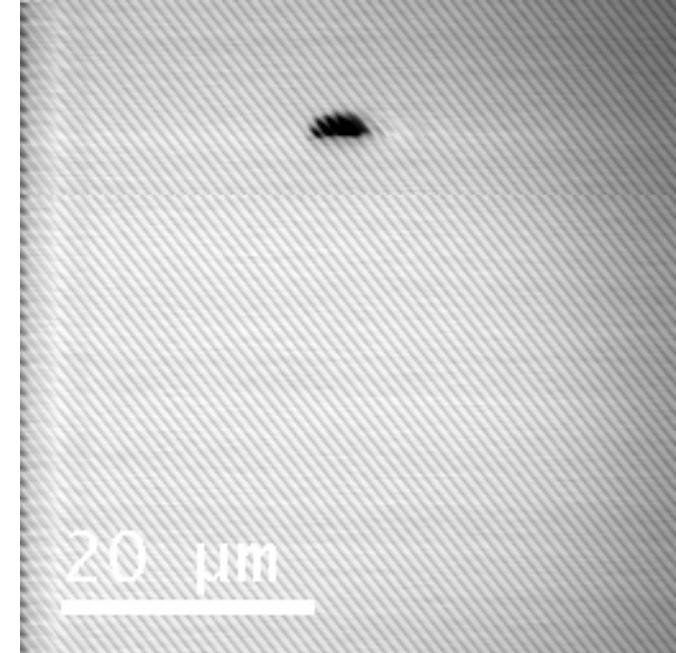
InAs/GaAs



InAs/InAs



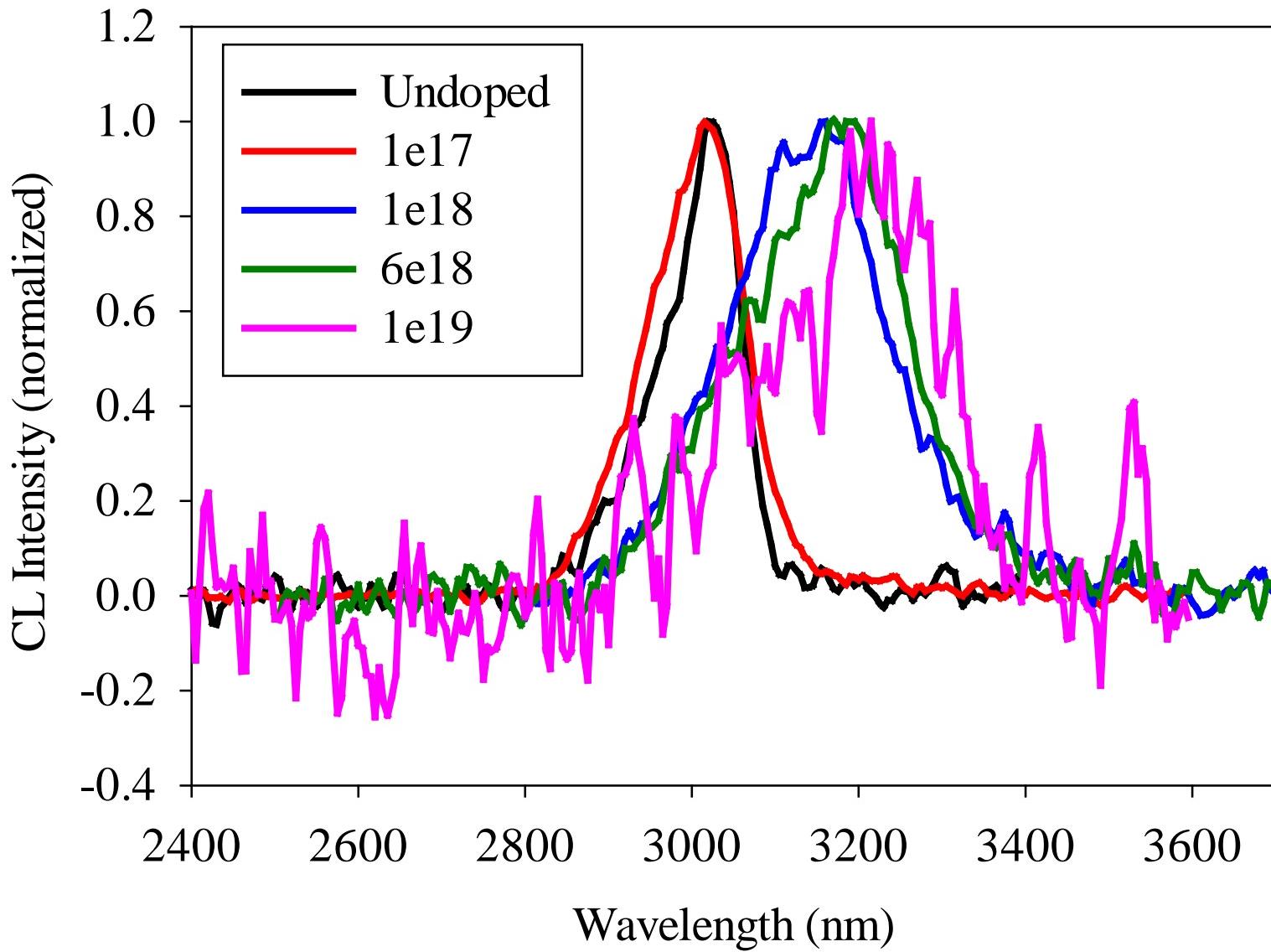
Defects in  
InAs/GaSb SLS  
(5  $\mu\text{m}$  cutoff)

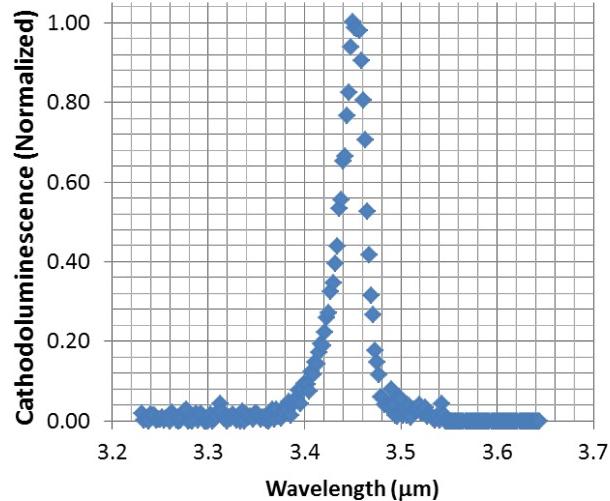
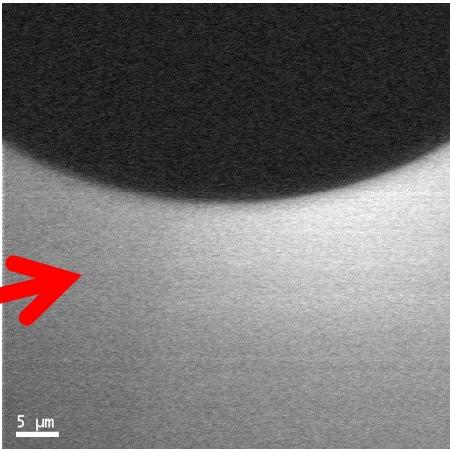
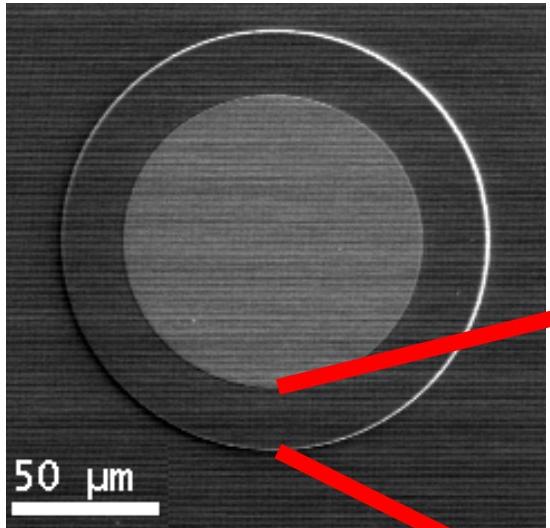


20  $\mu\text{m}$

**Various MWIR  
Images**

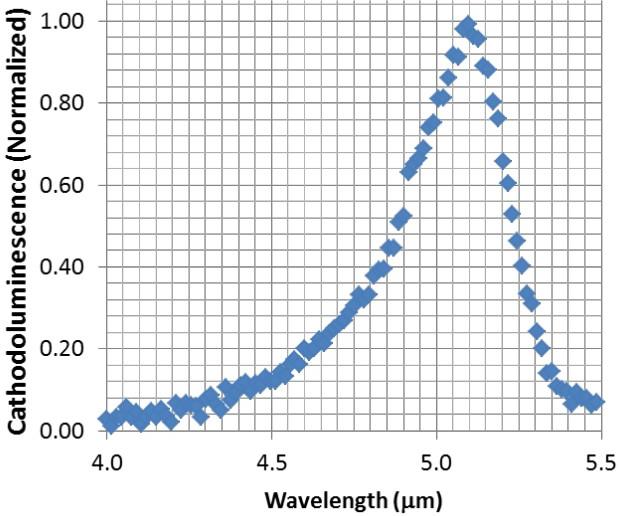
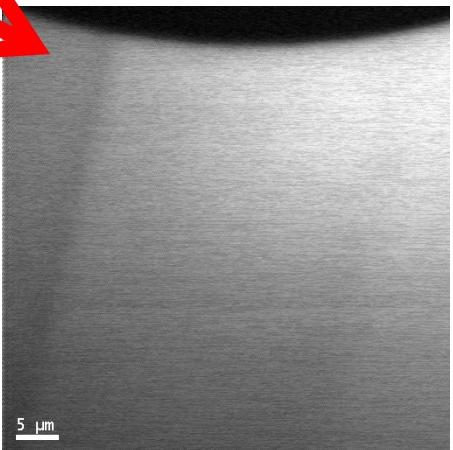
# CL Spectra InAs Various doping levels (80K)





SEM (left) and CL  
(right) of a mesa  
diode structure

Spectral CL of  
InAs/GaSb SLS  
Structure  
(80K)



# Questions?